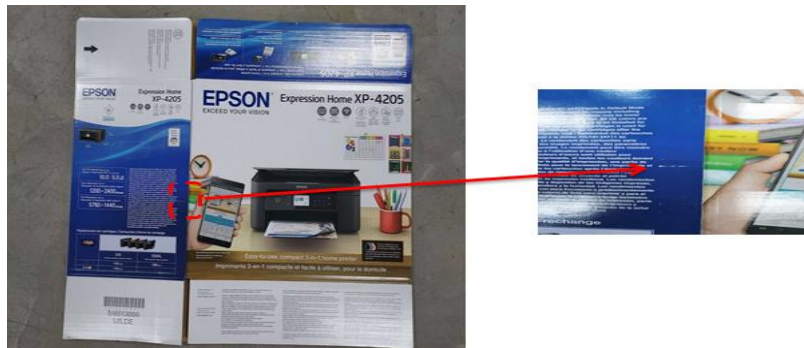


# INVESTIGATION REPORT FOR SCRATCHES OF LIGHT 2 MB AMERICA

## 51651300

DIRECT CAUSE METHOD (PROCESS)	W1: During process operator did not notice that they have scratches on panels. They notify during inspection. W2: Checking of raw mats at pallet to be process, they have scratches on raw mats that being die cutted. It is possible that the scraches issue is occur at die cut plate.
DIRECT CAUSE METHOD (PROCESS)	W1: Scratches occured due to die plate that is slightly opened (nakakawang) in the die chase. W2: Due to the utilization, the die plate was overused. W3: The die plate was no longer aligned in the die chase since it was used for a long time



## PRODUCTION ACTION PLAN

### IMMEDIATE ACTION

- > orient the operator regarding the issue of scratches
- > checking of raw mats. at the pallet.
- > Checking the next run for checking of condition of plate.
- > putting paper tape on plate

[illegible]